



MMBD3004BRM

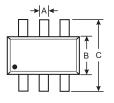
HIGH VOLTAGE SURFACE MOUNT SWITCHING DIODE ARRAY

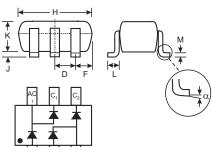
Features

- Two Series Diode Circuits Connect to Form Full Wave Bridge
- Fast Switching Speed
- High Conductance
- High Reverse Breakdown Voltage Rating
- Lead Free/RoHS Compliant Version (Note 3)
- "Green" Device (Note 4 and 5)

Mechanical Data

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Copper leadframe).
- Polarity: See Diagram
- Marking: KAE (See Page 2)
- Ordering Information: See Page 2
- Weight: 0.016 grams (approximate)





SOT-26									
Dim	Min	Max	Тур						
Α	0.35	0.50	0.38						
В	1.50	1.70	1.60						
С	2.70	3.00	2.80						
D			0.95						
F	_	_	0.55						
Н	2.90	3.10	3.00						
J	0.013	0.10	0.05						
K	1.00	1.30	1.10						
L	0.35	0.55	0.40						
M	0.10	0.20	0.15						
α	0°	8°							
All D	imens	ions in	mm						

Maximum Ratings @ T_A = 25°C unless otherwise specified, per element

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	350	V
Working Peak Reverse Voltage DC Blocking Voltage	V _{RWM} V _R	300	٧
RMS Reverse Voltage	V _{R(RMS)}	212	V
Forward Continuous Current (Note 1)	lF	225	mA
Peak Repetitive Forward Current (Note 1)	I _{FRM}	625	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s		4.0 1.0	А
Power Dissipation (Note 1)	Pd	350	mW
Thermal Resistance Junction to Ambient Air (Note 1)	R _{θJA}	357	°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	°C

Electrical Characteristics @ TA = 25°C unless otherwise specified, per element

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)		350	_		٧	$I_R = 150 \mu A$
Forward Voltage (Note 2)	VF	_	0.78 0.93 1.03	0.87 1.0 1.25	V	I _F = 20mA I _F = 100mA I _F = 200mA
Reverse Current (Note 2)	I _R	_	30 35	100 100	nΑ μΑ	$V_R = 240V$ $V_R = 240V$, $T_j = 150$ °C
Total Capacitance		_	1.0	5.0	pF	$V_R = 0V$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 3.0 \text{mA}, R_L = 100 \Omega$

- Notes: 1. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
 - 2. Short duration test pulse used to minimize self-heating effect.
 - 3. No purposefully added lead.
 - 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 - Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



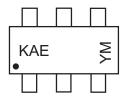
Ordering Information (Note 5 & 6)

Device	Packaging	Shipping		
MMBD3004BRM-7-F	SOT-26	3000/Tape & Reel		

5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

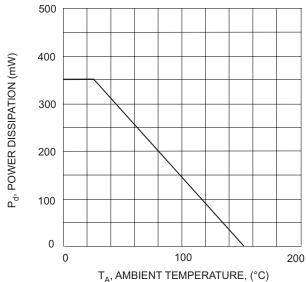


KAE = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

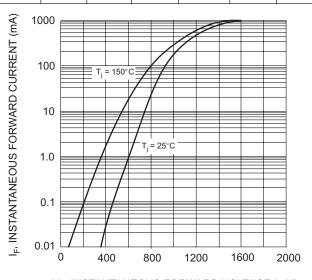
Date Code Key

Year	2003	2004	2005	2006	2007	2008	2009
Code	Р	R	S	Т	U	V	W

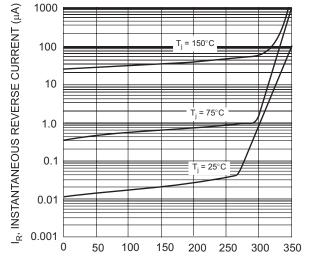
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D





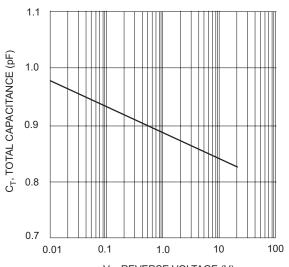


V_F, INSTANTANEOUS FORWARD VOLTAGE (mV) Fig. 2 Typical Forward Characteristics, per element



V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 3 Typical Reverse Characteristics, per element

Fig. 1 Power Derating Curve, total package



V_R, REVERSE VOLTAGE (V) Fig. 4 Typical Total Capacitance vs. Reverse Voltage, per element



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